

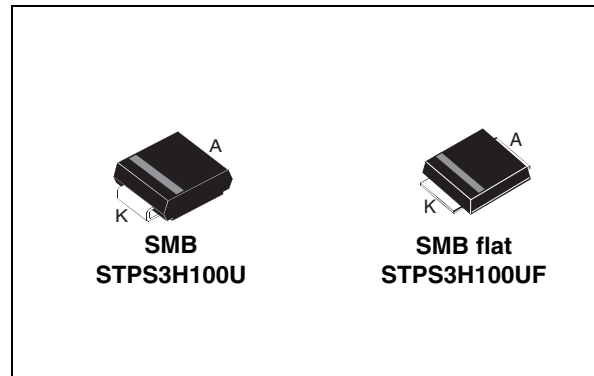
## SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

### Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche capability specified

### Description

These Schottky rectifiers are designed for high frequency miniature switched mode power supplies such as adaptators and on board DC/DC converters. They are available in SMB, and low-profile SMB.



**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	3 A
$V_{RRM}$	100 V
$T_j$ (max)	175 °C
$V_F$ (max)	0.68 V

# 1 Characteristics

**Table 2. Absolute ratings (limiting values)**

Symbol	Parameter		Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage		100	V	
$I_{F(AV)}$	Average forward current	SMB	$T_L = 115\text{ °C } \delta = 0.5$	3	A
		SMB flat	$T_L = 140\text{ °C } \delta = 0.5$		
$I_{FSM}$	Surge non repetitive forward current		$t_p = 10\text{ ms}$ sinusoidal	75	A
$P_{ARM}$	Repetitive peak avalanche power		$t_p = 1\text{ }\mu\text{s } T_j = 25\text{ °C}$	2400	W
$T_{stg}$	Storage temperature range		-65 to + 175	°C	
$T_j$	Operating junction temperature <sup>(1)</sup>		175	°C	

1.  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal resistance**

Symbol	Parameter		Value	Unit
$R_{th(j-l)}$	Junction to lead	SMB	25	°C/W
		SMB flat	15	

**Table 4. Static electrical characteristics**

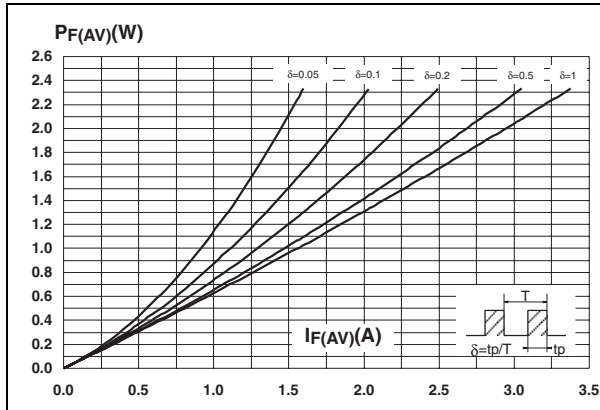
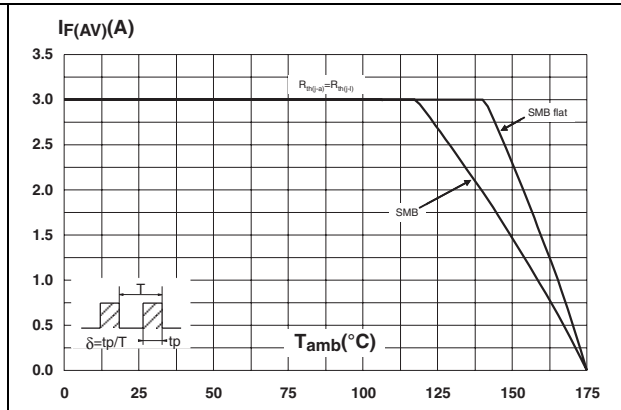
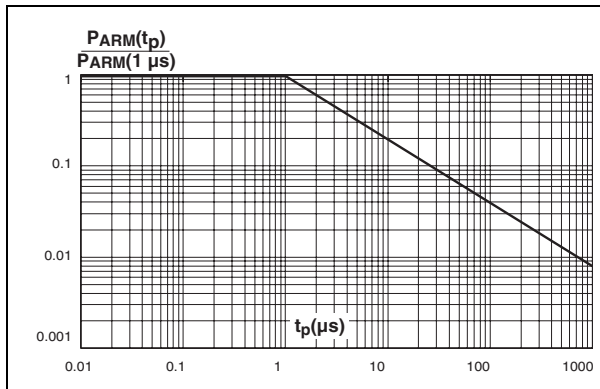
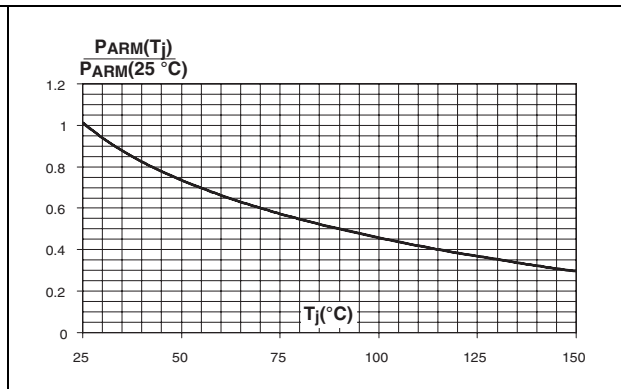
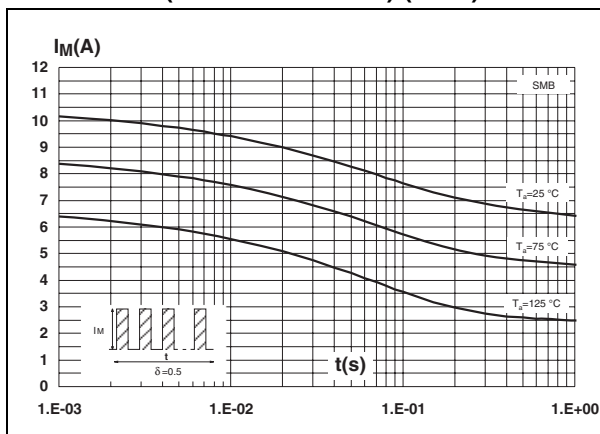
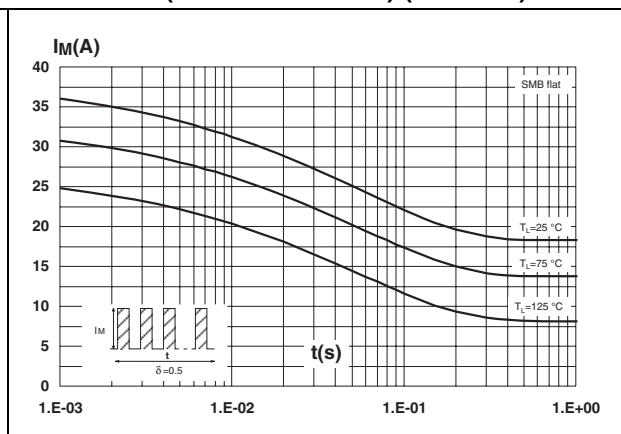
Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = V_{RRM}$	-	-	1	$\mu\text{A}$
		$T_j = 125\text{ °C}$		-	0.4	1	mA
$V_F^{(2)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 3\text{ A}$	-	-	0.84	V
		$T_j = 125\text{ °C}$		-	0.63	0.68	
		$T_j = 25\text{ °C}$	$I_F = 6\text{ A}$	-	-	0.92	
		$T_j = 125\text{ °C}$		-	0.71	0.76	

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

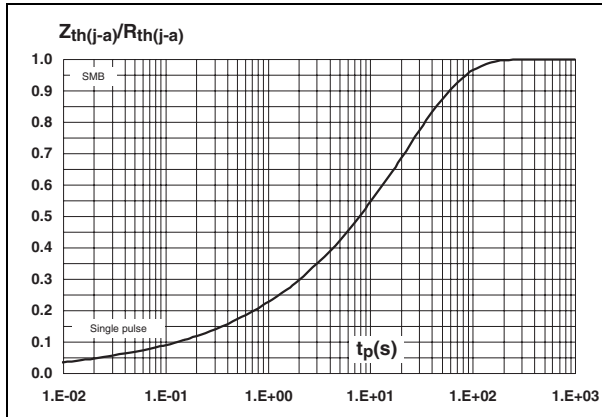
2. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

To evaluate the conduction losses use the following equation:

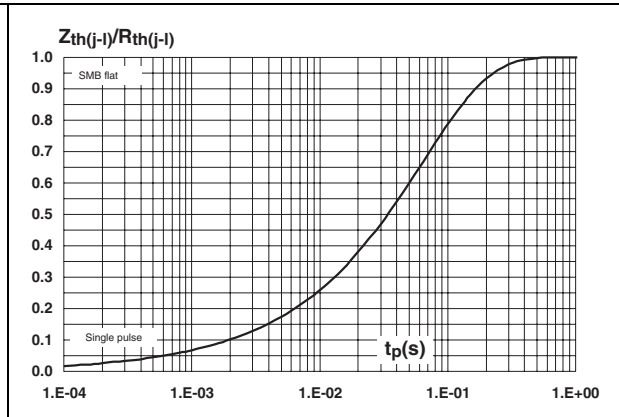
$$P = 0.6 \times I_{F(AV)} + 0.027 I_{F(RMS)}^2$$

**Figure 1. Average forward power dissipation versus average forward current**

**Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ )**

**Figure 3. Normalized avalanche power derating versus pulse duration**

**Figure 4. Normalized avalanche power derating versus junction temperature**

**Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) (SMB)**

**Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values) (SMB flat)**


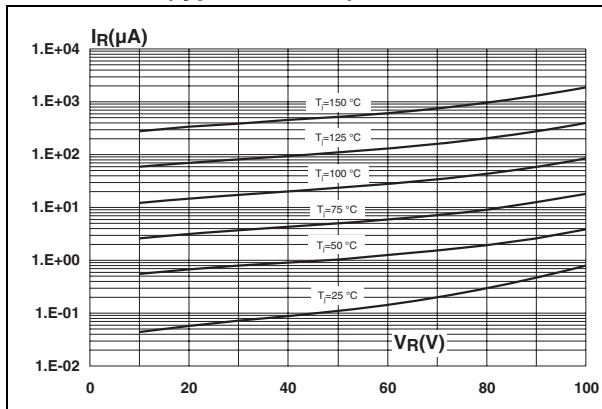
**Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration (SMB)**



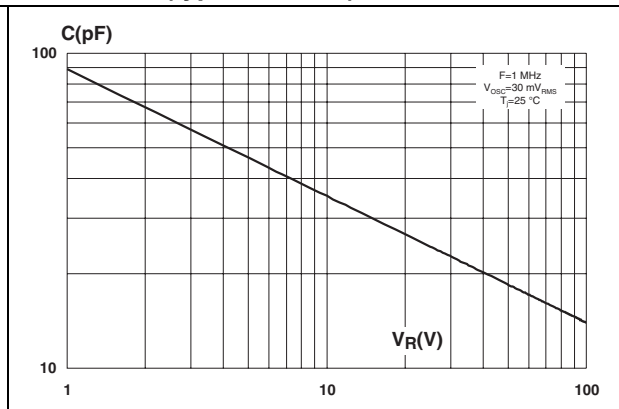
**Figure 8. Relative variation of thermal impedance junction to lead versus pulse duration (SMB flat)**



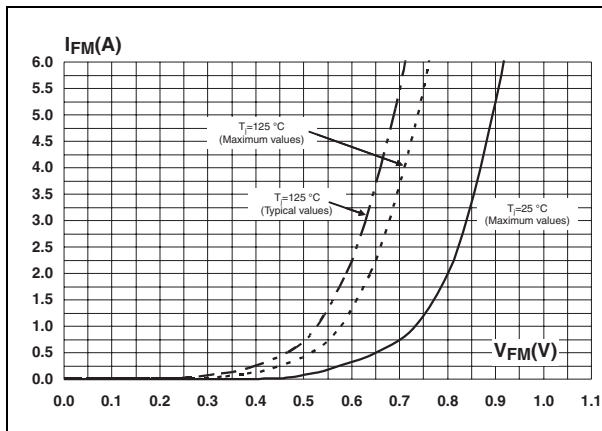
**Figure 9. Reverse leakage current versus reverse voltage applied (typical values)**



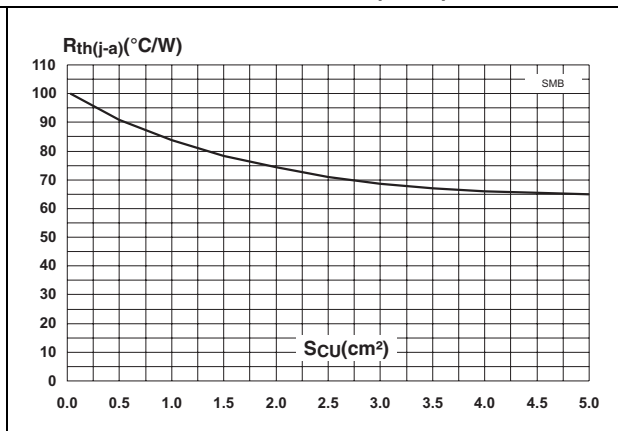
**Figure 10. Junction capacitance versus reverse voltage applied (typical values)**



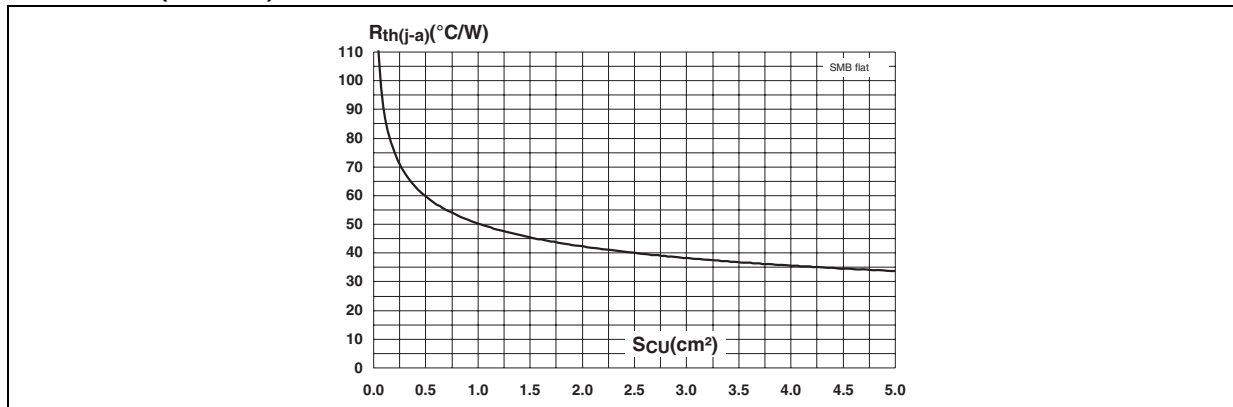
**Figure 11. Forward voltage drop versus forward current**



**Figure 12. Thermal resistance junction to ambient versus copper surface under each lead (SMB)**



**Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (SMBflat)**

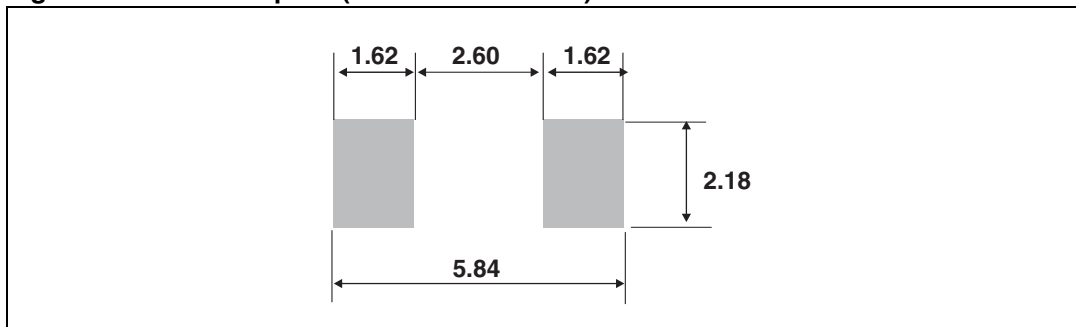


## 2 Package Information

Table 5. SMB dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
D	3.30	3.95	0.130	0.156
L	0.75	1.50	0.030	0.059

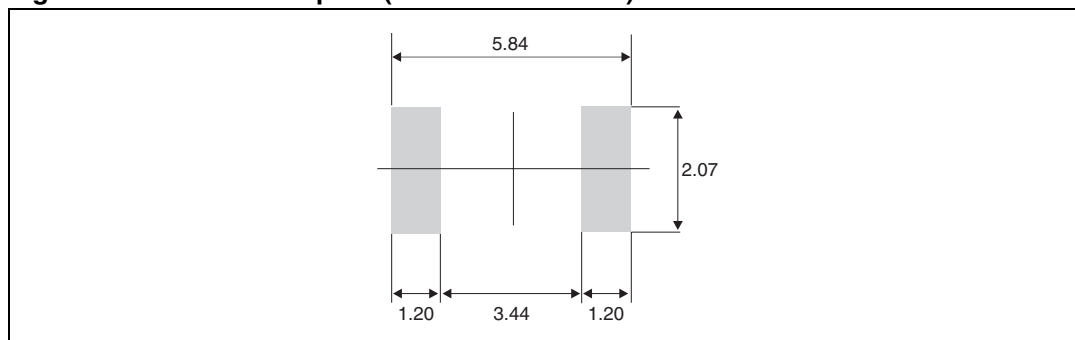
Figure 14. SMB footprint (dimensions in mm)



**Table 6. SMBflat dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
b <sup>(1)</sup>	1.95		2.20	0.077		0.087
c <sup>(1)</sup>	0.15		0.40	0.006		0.016
D	3.30		3.95	0.130		0.156
E	5.10		5.60	0.200		0.220
E1	4.05		4.60	0.189		0.181
L	0.75		1.50	0.029		0.059
L1		0.40			0.016	
L2		0.60			0.024	

1. Applies to plated leads

**Figure 15. SMBflat footprint (dimensions in mm)**


### 3 Ordering information

**Table 7. Ordering information**

<b>Order code</b>	<b>Marking</b>	<b>Package</b>	<b>Weight</b>	<b>Base qty</b>	<b>Delivery mode</b>
STPS3H100	SS310	SMB	0.107 g	3000	Tape and reel
STPS3H100UF	S310	SMB flat	0.050g	3000	Tape and reel



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